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### Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

### Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

Product Status	Obsolete
Core Processor	PowerPC G2
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	166MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (3)
SATA	-
USB	-
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 105°C (TA)
Security Features	-
Package / Case	480-LBGA Exposed Pad
Supplier Device Package	480-TBGA (37.5x37.5)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8260acvvmhbb">https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8260acvvmhbb</a>

Figure 1 shows the block diagram for the MPC8266, the HiP4 superset device. Shaded portions indicate functionality that is not available on all devices; refer to the notes.

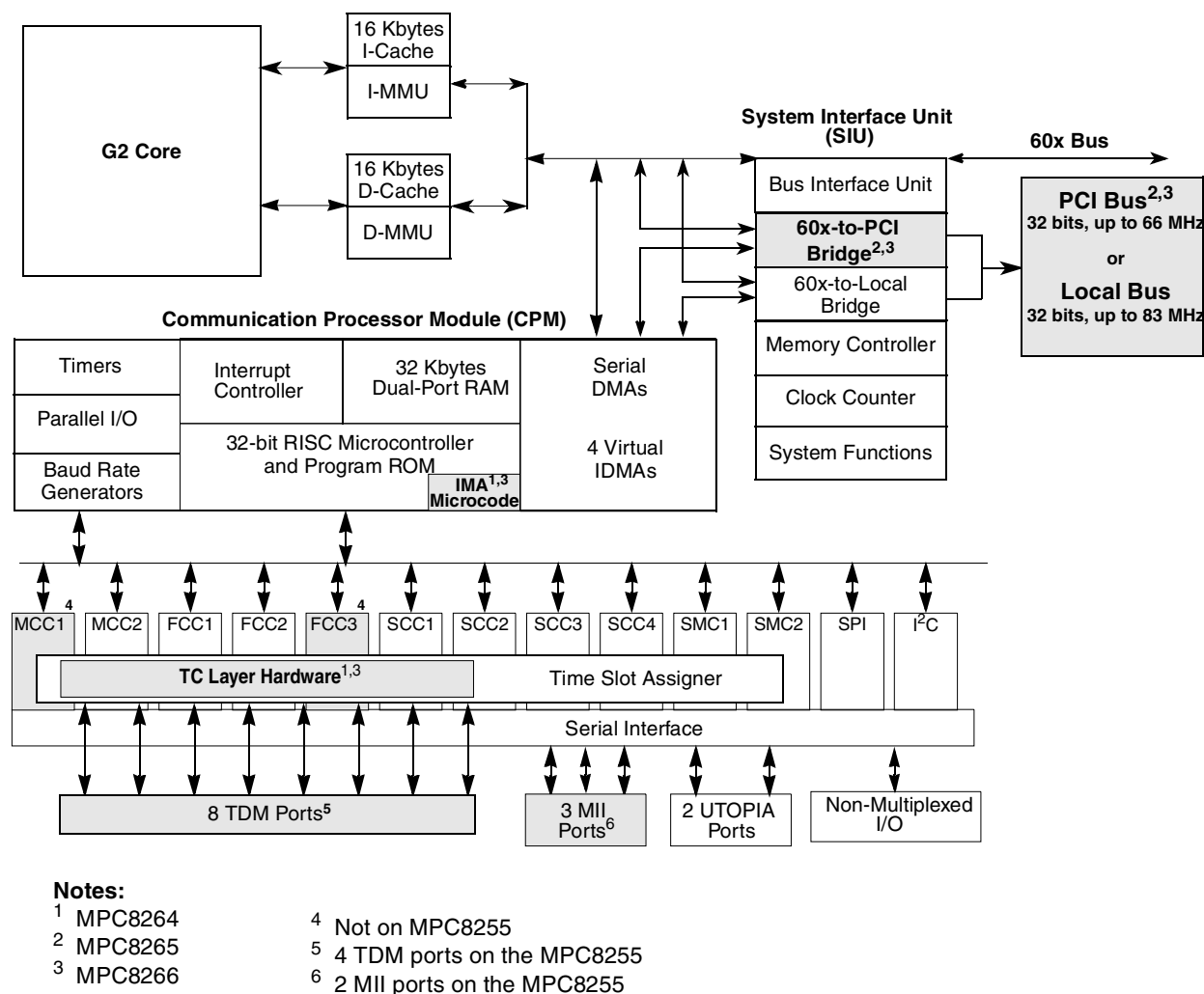


Figure 1. MPC8266 Block Diagram

# 1 Features

The major features of the MPC826xA family are as follows:

- Dual-issue integer core
  - A core version of the EC603e microprocessor
  - System core microprocessor supporting frequencies of 150–300 MHz
  - Separate 16-Kbyte data and instruction caches:
    - Four-way set associative
    - Physically addressed
    - LRU replacement algorithm

- PowerPC architecture-compliant memory management unit (MMU)
- Common on-chip processor (COP) test interface
- High-performance (6.6–7.65 SPEC95 benchmark at 300 MHz; 1.68 MIPS/MHz without inlining and 1.90 Dhrystones MIPS/MHz with
- Supports bus snooping for data cache coherency
- Floating-point unit (FPU)
- Separate power supply for internal logic and for I/O
- Separate PLLs for G2 core and for the CPM
  - G2 core and CPM can run at different frequencies for power/performance optimization
  - Internal core/bus clock multiplier that provides 1.5:1, 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1 ratios
  - Internal CPM/bus clock multiplier that provides 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1 ratios
- 64-bit data and 32-bit address 60x bus
  - Bus supports multiple master designs
  - Supports single- and four-beat burst transfers
  - 64-, 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
  - Supports data parity or ECC and address parity
- 32-bit data and 18-bit address local bus
  - Single-master bus, supports external slaves
  - Eight-beat burst transfers
  - 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
- 60x-to-PCI bridge (MPC8265 and MPC8266 only)
  - Programmable host bridge and agent
  - 32-bit data bus, 66 MHz, 3.3 V
  - Synchronous and asynchronous 60x and PCI clock modes
  - All internal address space available to external PCI host
  - DMA for memory block transfers
  - PCI-to-60x address remapping
- System interface unit (SIU)
  - Clock synthesizer
  - Reset controller
  - Real-time clock (RTC) register
  - Periodic interrupt timer
  - Hardware bus monitor and software watchdog timer
  - IEEE Std. 1149.1™ standard JTAG test access port
- Twelve-bank memory controller
  - Glueless interface to SRAM, page mode SDRAM, DRAM, EPROM, Flash and other user-definable peripherals
  - Byte write enables and selectable parity generation

- Transparent
- UART (low-speed operation)
- One serial peripheral interface identical to the MPC860 SPI
- One inter-integrated circuit (I<sup>2</sup>C) controller (identical to the MPC860 I<sup>2</sup>C controller)
  - Microwire compatible
  - Multiple-master, single-master, and slave modes
- Up to eight TDM interfaces (four on the MPC8255)
  - Supports two groups of four TDM channels for a total of eight TDMs
  - 2,048 bytes of SI RAM
  - Bit or byte resolution
  - Independent transmit and receive routing, frame synchronization
  - Supports T1, CEPT, T1/E1, T3/E3, pulse code modulation highway, ISDN basic rate, ISDN primary rate, Freescale interchip digital link (IDL), general circuit interface (GCI), and user-defined TDM serial interfaces
- Eight independent baud rate generators and 20 input clock pins for supplying clocks to FCCs, SCCs, SMCs, and serial channels
- Four independent 16-bit timers that can be interconnected as two 32-bit timers

Additional features of the MPC826xA family are as follows:

- CPM
  - 32-Kbyte dual-port RAM
  - Additional MCC host commands
  - Eight transfer transmission convergence (TC) layers between the TDMs and FCC2 to support inverse multiplexing for ATM capabilities (IMA) (MPC8264 and MPC8266 only)
- CPM multiplexing
  - FCC2 can also be connected to the TC layer.
- TC layer (MPC8264 and MPC8266 only)
  - Each of the 8 TDM channels is routed in hardware to a TC layer block
    - Protocol-specific overhead bits may be discarded or routed to other controllers by the SI
    - Performing ATM TC layer functions (according to ITU-T I.432)
      - Transmit (Tx) updates
        - Cell HEC generation
        - Payload scrambling using self synchronizing scrambler (programmable by the user)
        - Coset generation (programmable by the user)
        - Cell rate by inserting idle/unassigned cells
      - Receive (Rx) updates
        - Cell delineation using bit by bit HEC checking and programmable ALPHA and DELTA parameters for the delineation state machine
        - Payload descrambling using self synchronizing scrambler (programmable by the user)

Table 3. DC Electrical Characteristics<sup>1</sup> (continued)

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 7.0 \text{ mA}$ $\overline{BR}$ $\overline{BG}$ $\overline{ABB/IRQ2}$ $\overline{TS}$ $A[0-31]$ $TT[0-4]$ $\overline{TBST}$ $TSIZE[0-3]$ $\overline{AACK}$ $\overline{ARTRY}$ $\overline{DBG}$ $\overline{DBB/IRQ3}$ $D[0-63]$ $DP(0)/\overline{RSRV/EXT\_BR2}$ $DP(1)/\overline{IRQ1/EXT\_BG2}$ $DP(2)/\overline{TLBISYNC/IRQ2/EXT\_DBG2}$ $DP(3)/\overline{IRQ3/EXT\_BR3/CKSTP\_OUT}$ $DP(4)/\overline{IRQ4/EXT\_BG3/CORE\_SREST}$ $DP(5)/\overline{TBEN/IRQ5/EXT\_DBG3}$ $DP(6)/\overline{CSE(0)/IRQ6}$ $DP(7)/\overline{CSE(1)/IRQ7}$ $\overline{PSDVAL}$ $\overline{TA}$ $\overline{TEA}$ $\overline{GBL/IRQ1}$ $\overline{CI/BADDR29/IRQ2}$ $\overline{WT/BADDR30/IRQ3}$ $\overline{L2\_HIT/IRQ4}$ $\overline{CPU\_BG/BADDR31/IRQ5}$ $\overline{CPU\_DBG}$ $\overline{CPU\_BR}$ $\overline{IRQ0/NMI\_OUT}$ $\overline{IRQ7/INT\_OUT/APE}$ $\overline{PORESET}$ $\overline{HRESET}$ $\overline{SRESET}$ $\overline{RSTCONF}$ $\overline{QREQ}$	$V_{OL}$	—	0.4	V

## 2.4 AC Electrical Characteristics

The following sections include illustrations and tables of clock diagrams, signals, and CPM outputs and inputs for the 66 MHz MPC826xA device. Note that AC timings are based on a 50-pf load. Typical output buffer impedances are shown in Table 6.

**Table 6. Output Buffer Impedances<sup>1</sup>**

Output Buffers	Typical Impedance ( $\Omega$ )
60x bus	40
Local bus	40
Memory controller	40
Parallel I/O	46
PCI	25

<sup>1</sup> These are typical values at 65° C. The impedance may vary by  $\pm 25\%$  with process and temperature.

Table 7 lists CPM output characteristics.

**Table 7. AC Characteristics for CPM Outputs<sup>1</sup>**

Spec Number		Characteristic	Max Delay (ns)		Min Delay (ns)	
Max	Min		66 MHz	83 MHz	66 MHz	83 MHz
sp36a	sp37a	FCC outputs—internal clock (NMSI)	6	5.5	1	1
sp36b	sp37b	FCC outputs—external clock (NMSI)	14	12	2	1
sp40	sp41	TDM outputs/SI	25	16	5	4
sp38a	sp39a	SCC/SMC/SPI/I2C outputs—internal clock (NMSI)	19	16	1	0.5
sp38b	sp39b	Ex_SCC/SMC/SPI/I2C outputs—external clock (NMSI)	19	16	2	1
sp42	sp43	TIMER/IDMA outputs	14	11	1	0.5
sp42a	sp43a	PIO outputs	14	11	0.5	0.5

<sup>1</sup> Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

Figure 9 shows the interaction of several bus signals.

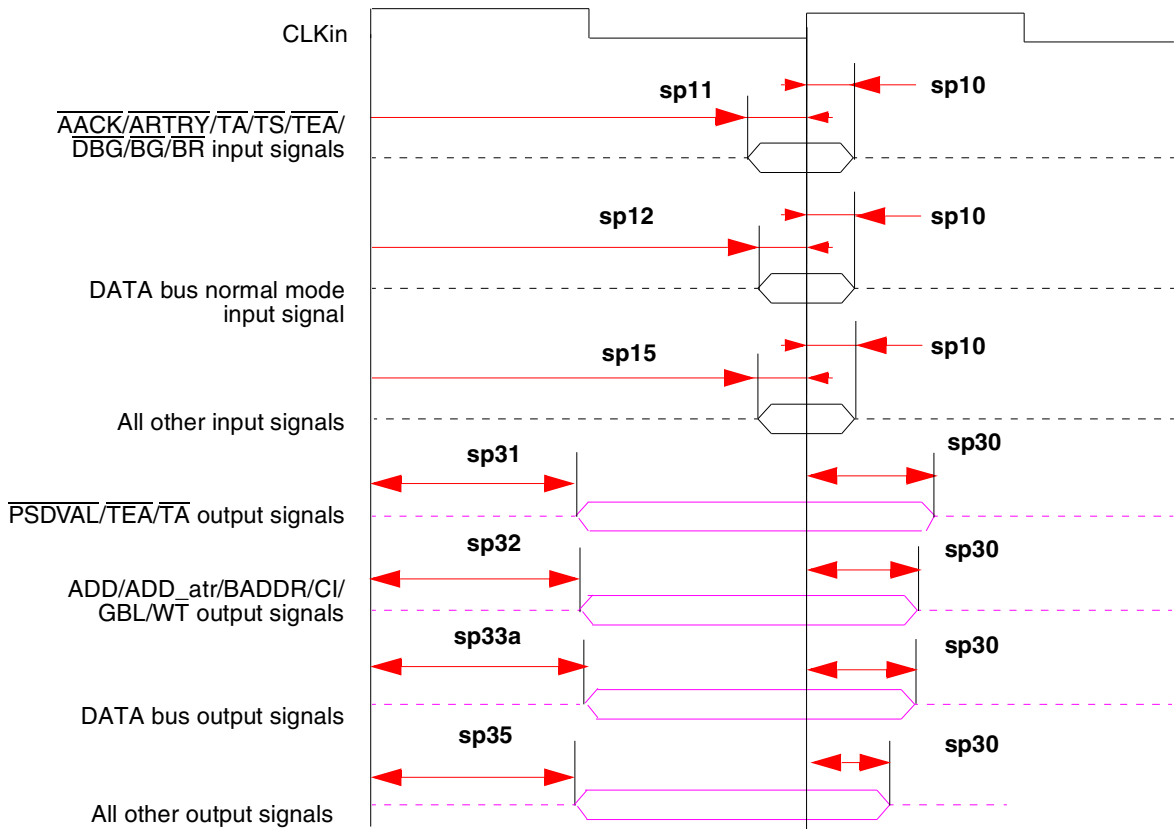


Figure 9. Bus Signals

Figure 10 shows signal behavior for all parity modes (including ECC, RMW parity, and standard parity).

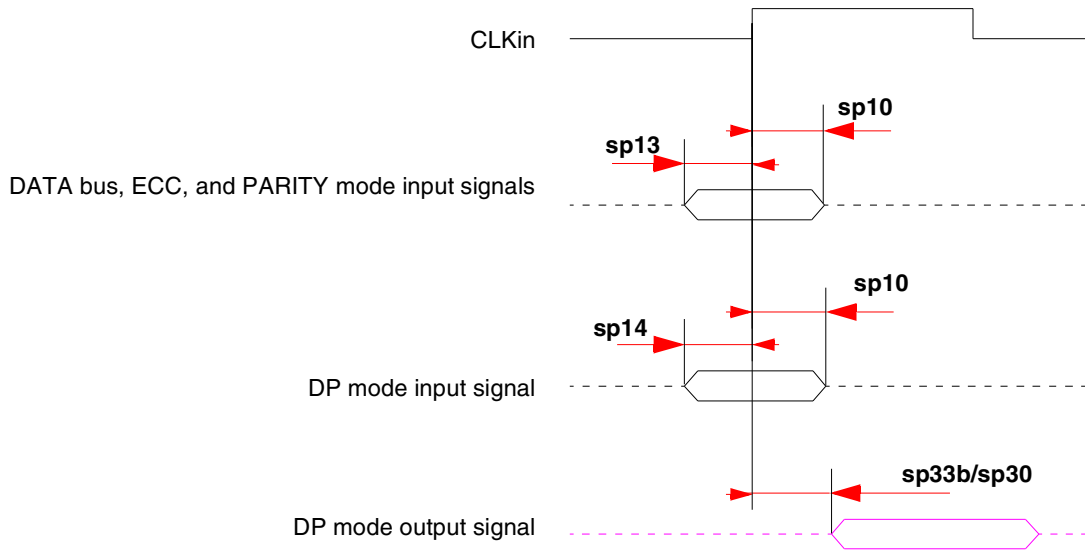


Figure 10. Parity Mode Diagram

Figure 11 shows signal behavior in MEMC mode.

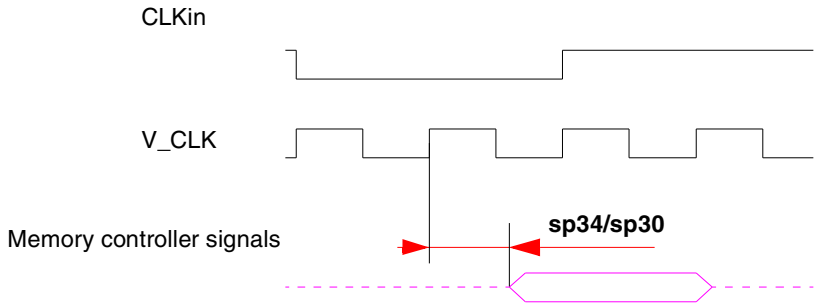


Figure 11. MEMC Mode Diagram

**NOTE**

Generally, all MPC826xA bus and system output signals are driven from the rising edge of the input clock (CLKIn). Memory controller signals, however, trigger on four points within a CLKIn cycle. Each cycle is divided by four internal ticks: T1, T2, T3, and T4. T1 always occurs at the rising edge, and T3 at the falling edge, of CLKIn. However, the spacing of T2 and T4 depends on the PLL clock ratio selected, as shown in Table 11.

Table 11. Tick Spacing for Memory Controller Signals

PLL Clock Ratio	Tick Spacing (T1 Occurs at the Rising Edge of CLKIn)		
	T2	T3	T4
1:2, 1:3, 1:4, 1:5, 1:6	1/4 CLKIn	1/2 CLKIn	3/4 CLKIn
1:2.5	3/10 CLKIn	1/2 CLKIn	8/10 CLKIn
1:3.5	4/14 CLKIn	1/2 CLKIn	11/14 CLKIn

Figure 12 is a graphical representation of Table 11.

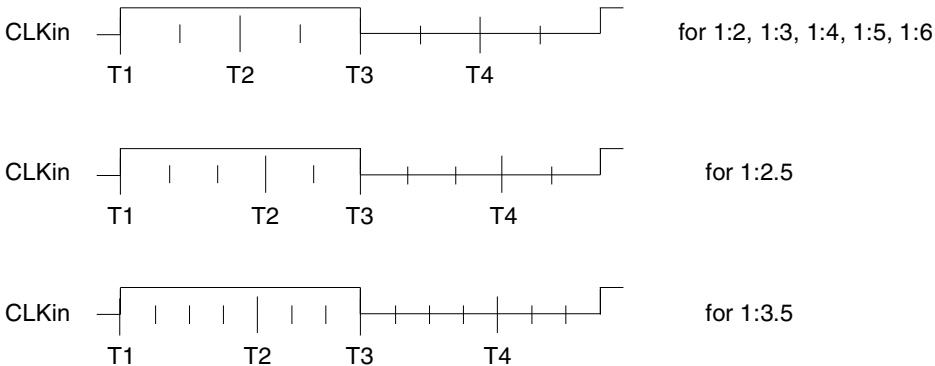


Figure 12. Internal Tick Spacing for Memory Controller Signals



Table 12 lists the JTAG timings.

**Table 12. JTAG Timings<sup>1</sup>**

Parameter	Symbol <sup>2</sup>	Min	Max	Unit	Notes
JTAG external clock frequency of operation	$f_{JTG}$	0	25	MHz	—
JTAG external clock cycle time	$t_{JTG}$	40	—	ns	—
JTAG external clock pulse width measured at 1.4V	$t_{JTKHKL}$	20	—	ns	—
JTAG external clock rise and fall times	$t_{JTGR}$ and $t_{JTGF}$	0	5	ns	6
TRST assert time	$t_{TRST}$	25	—	ns	3, 6
Input setup times	Boundary-scan data	$t_{JTDVKH}$	4	ns	4, 7
	TMS, TDI	$t_{JTIVKH}$	4	ns	4, 7
Input hold times	Boundary-scan data	$t_{JTDXKH}$	10	ns	4, 7
	TMS, TDI	$t_{JTIXKH}$	10	ns	4, 7
Output valid times	Boundary-scan data	$t_{JTKLDV}$	—	ns	5, 7
	TDO	$t_{JTKLOV}$	25	ns	5, 7
Output hold times	Boundary-scan data	$t_{JTKLDX}$	1	ns	5, 7
	TDO	$t_{JTKLOX}$	1	ns	5, 7
JTAG external clock to output high impedance	Boundary-scan data	$t_{JTKLDZ}$	1	ns	5, 6
	TDO	$t_{JTKLOZ}$	1	ns	5, 6

<sup>1</sup> All outputs are measured from the midpoint voltage of the falling/rising edge of  $t_{TCLK}$  to the midpoint of the signal in question. The output timings are measured at the pins. All output timings assume a purely resistive 50-Ω load. Time-of-flight delays must be added for trace lengths, vias, and connectors in the system.

<sup>2</sup> The symbols used for timing specifications herein follow the pattern of  $t_{(first\ two\ letters\ of\ functional\ block)(signal)(state)}$  (reference)(state) for inputs and  $t_{(first\ two\ letters\ of\ functional\ block)(reference)(state)(signal)(state)}$  for outputs. For example,  $t_{JTDVKH}$  symbolizes JTAG device timing (JT) with respect to the time data input signals (D) reaching the valid state (V) relative to the  $t_{JTG}$  clock reference (K) going to the high (H) state or setup time. Also,  $t_{JTDXKH}$  symbolizes JTAG timing (JT) with respect to the time data input signals (D) went invalid (X) relative to the  $t_{JTG}$  clock reference (K) going to the high (H) state. Note that, in general, the clock reference symbol representation is based on three letters representing the clock of a particular functional. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).

<sup>3</sup> TRST is an asynchronous level sensitive signal. The setup time is for test purposes only.

<sup>4</sup> Non-JTAG signal input timing with respect to  $t_{TCLK}$ .

<sup>5</sup> Non-JTAG signal output timing with respect to  $t_{TCLK}$ .

<sup>6</sup> Guaranteed by design.

<sup>7</sup> Guaranteed by design and device characterization.

#### NOTE

The UPM machine outputs change on the internal tick determined by the memory controller programming; the AC specifications are relative to the internal tick. Note that SDRAM and GPCM machine outputs change on CLKIn's rising edge.

Table 14. Clock Configuration Modes<sup>1</sup> (continued)

MODCK_H–MODCK[1–3]	Input Clock Frequency <sup>2,3</sup>	CPM Multiplication Factor <sup>2</sup>	CPM Frequency <sup>2</sup>	Core Multiplication Factor <sup>2</sup>	Core Frequency <sup>2</sup>
0100_111	Reserved				
0101_000					
0101_001					
0101_010					
0101_011					
0101_100					
0101_101	66 MHz	2	133 MHz	2	133 MHz
0101_110	<b>66 MHz</b>	<b>2</b>	<b>133 MHz</b>	<b>2.5</b>	<b>166 MHz</b>
0101_111	<b>66 MHz</b>	<b>2</b>	<b>133 MHz</b>	<b>3</b>	<b>200 MHz</b>
0110_000	66 MHz	2	133 MHz	3.5	233 MHz
0110_001	66 MHz	2	133 MHz	4	266 MHz
0110_010	66 MHz	2	133 MHz	4.5	300 MHz
0110_011	66 MHz	2.5	166 MHz	2	133 MHz
0110_100	<b>66 MHz</b>	<b>2.5</b>	<b>166 MHz</b>	<b>2.5</b>	<b>166 MHz</b>
0110_101	<b>66 MHz</b>	<b>2.5</b>	<b>166 MHz</b>	<b>3</b>	<b>200 MHz</b>
0110_110	66 MHz	2.5	166 MHz	3.5	233 MHz
0110_111	66 MHz	2.5	166 MHz	4	266 MHz
0111_000	66 MHz	2.5	166 MHz	4.5	300 MHz
0111_001	66 MHz	3	200 MHz	2	133 MHz
0111_010	66 MHz	3	200 MHz	2.5	166 MHz
0111_011	66 MHz	3	200 MHz	3	200 MHz
0111_100	66 MHz	3	200 MHz	3.5	233 MHz
0111_101	66 MHz	3	200 MHz	4	266 MHz
0111_110	66 MHz	3	200 MHz	4.5	300 MHz
0111_111	66 MHz	3.5	233 MHz	2	133 MHz
1000_000	66 MHz	3.5	233 MHz	2.5	166 MHz

Table 14. Clock Configuration Modes<sup>1</sup> (continued)

MODCK_H–MODCK[1–3]	Input Clock Frequency <sup>2,3</sup>	CPM Multiplication Factor <sup>2</sup>	CPM Frequency <sup>2</sup>	Core Multiplication Factor <sup>2</sup>	Core Frequency <sup>2</sup>
1000_001	66 MHz	3.5	233 MHz	3	200 MHz
1000_010	66 MHz	3.5	233 MHz	3.5	233 MHz
1000_011	66 MHz	3.5	233 MHz	4	266 MHz
1000_100	66 MHz	3.5	233 MHz	4.5	300 MHz

<sup>1</sup> Because of speed dependencies, not all of the possible configurations in Table 14 are applicable.

<sup>2</sup> The user should choose the input clock frequency and the multiplication factors such that the frequency of the CPU is equal to or greater than 150 MHz and the CPM ranges between 66–233 MHz.

<sup>3</sup> Input clock frequency is given only for the purpose of reference. The user should set MODCK\_H–MODCK\_L so that the resulting configuration does not exceed the frequency rating of the user's part.

## 3.2 PCI Mode

The MPC8265 and the MPC8266 have three clocking modes: local, PCI host, and PCI agent. The clocking mode is set according to three input pins—PCI\_MODE, PCI\_CFG[0], PCI\_MODCK—as shown in Table 15.

Table 15. MPC8265 and MPC8266 Clocking Modes

Pins			Clocking Mode	PCI Clock Frequency Range (MHZ)
PCI_MODE	PCI_CFG[0]	PCI_MODCK		
1	—	—	Local bus	—
0	0	0	PCI host	50–66
0	0	1		25–50
0	1	0	PCI agent	50–66
0	1	1		25–50

In addition, note the following:

### NOTE: PCI\_MODCK

In PCI mode only, PCI\_MODCK comes from the LGPL5 pin and MODCK\_H[0–3] comes from {LGPL0, LGPL1, LGPL2, LGPL3}.

### NOTE: Tval (Output Hold)

The minimum Tval = 2 when PCI\_MODCK = 1, and the minimum Tval = 1 when PCI\_MODCK = 0. Therefore, designers should use clock configurations that fit this condition to achieve PCI-compliant AC timing.

### NOTE

Clock configurations change only after  $\overline{\text{POR}}$  is asserted.

### 3.2.1 PCI Host Mode

The frequencies listed in [Table 16](#) and [Table 17](#) are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device.

**Table 16. Clock Default Configurations in PCI Host Mode (MODCK\_HI = 0000)**

MODCK[1–3] <sup>1</sup>	Input Clock Frequency (Bus)	CPM Multiplication Factor	CPM Frequency	Core Multiplication Factor	Core Frequency	PCI Division Factor <sup>2</sup>	PCI Frequency <sup>2</sup>
000	66 MHz	2	133 MHz	2.5	166 MHz	2/4	66/33 MHz
001	66 MHz	2	133 MHz	3	200 MHz	2/4	66/33 MHz
010	66 MHz	2.5	166 MHz	3	200 MHz	3/6	55/28 MHz
011	66 MHz	2.5	166 MHz	3.5	233 MHz	3/6	55/28 MHz
100	66 MHz	2.5	166 MHz	4	266 MHz	3/6	55/28 MHz
101	66 MHz	3	200 MHz	3	200 MHz	3/6	66/33 MHz
110	66 MHz	3	200 MHz	3.5	233 MHz	3/6	66/33 MHz
111	66 MHz	3	200 MHz	4	266 MHz	3/6	66/33 MHz

<sup>1</sup> Assumes MODCK\_HI = 0000.

<sup>2</sup> The frequency depends on the value of PCI\_MODCK. If PCI\_MODCK is high (logic '1'), the PCI frequency is divided by 2 (33 instead of 66 MHz, etc.) Refer to [Table 15](#).

[Table 17](#) describes all possible clock configurations when using the MPC8265's or the MPC8266's internal PCI bridge in host mode.

**Table 17. Clock Configuration Modes in PCI Host Mode**

MODCK_H – MODCK[1–3]	Input Clock Frequency <sup>1</sup> (Bus)	CPM Multiplication Factor	CPM Frequency	Core Multiplication Factor	Core Frequency	PCI Division Factor <sup>2</sup>	PCI Frequency <sup>2</sup>
0001_000	33 MHz	3	100 MHz	5	166 MHz	3/6	33/16 MHz
0001_001	33 MHz	3	100 MHz	6	200 MHz	3/6	33/16 MHz
0001_010	33 MHz	3	100 MHz	7	233 MHz	3/6	33/16 MHz
0001_011	33 MHz	3	100 MHz	8	266 MHz	3/6	33/16 MHz
0010_000	<b>33 MHz</b>	<b>4</b>	<b>133 MHz</b>	<b>5</b>	<b>166 MHz</b>	<b>4/8</b>	<b>33/16 MHz</b>
0010_001	33 MHz	4	133 MHz	6	200 MHz	4/8	33/16 MHz
0010_010	33 MHz	4	133 MHz	7	233 MHz	4/8	33/16 MHz
0010_011	33 MHz	4	133 MHz	8	266 MHz	4/8	33/16 MHz
0011_000 <sup>3</sup>	33 MHz	5	166 MHz	5	166 MHz	5	<b>33 MHz</b>
0011_001 <sup>3</sup>	33 MHz	5	166 MHz	6	200 MHz	5	33 MHz
0011_010 <sup>3</sup>	33 MHz	5	166 MHz	7	233 MHz	5	33 MHz

# 4 Pinout

This section provides the pin assignments and pinout list for the MPC826xA.

## 4.1 Pin Assignments

Figure 13 shows the pinout of the MPC826xA's 480 TBGA package as viewed from the top surface.

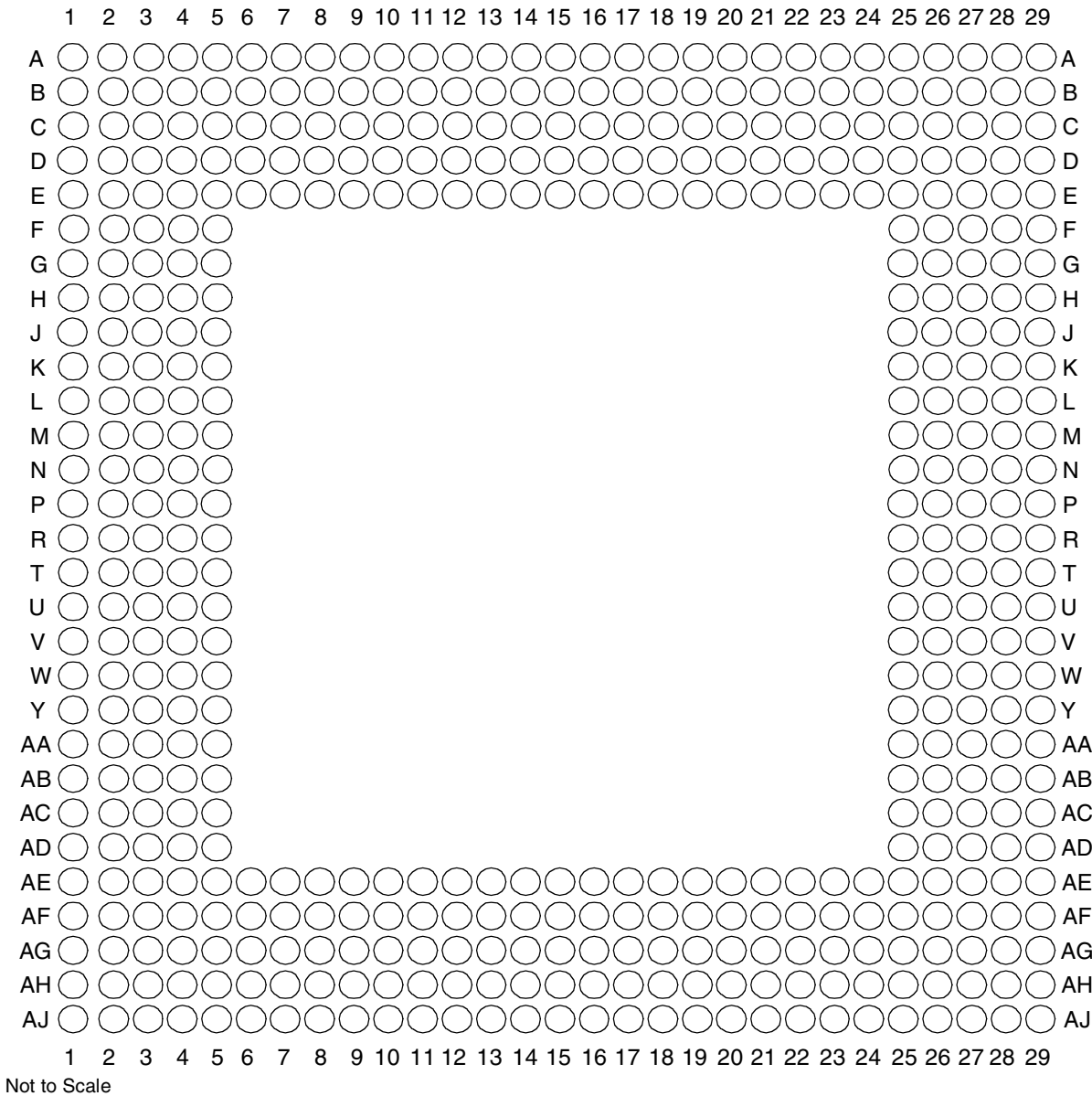


Figure 13. Pinout of the 480 TBGA Package as Viewed from the Top Surface

Figure 14 shows the side profile of the TBGA package to indicate the direction of the top surface view.

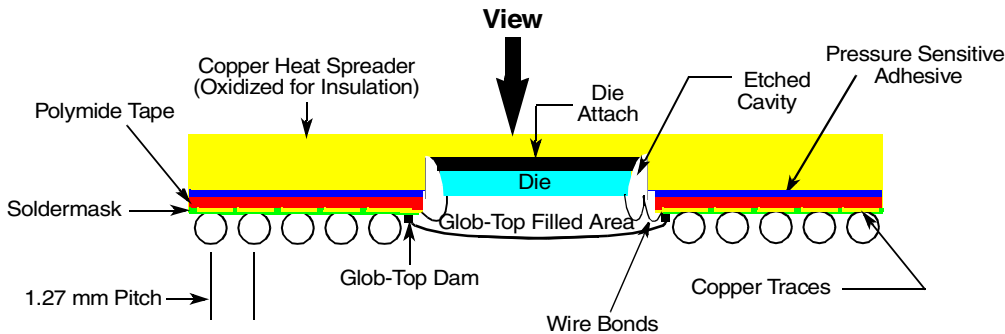


Figure 14. Side View of the TBGA Package

Table 21 shows the pinout list of the MPC826xA. Table 20 defines conventions and acronyms used in Table 21.

Symbols used in Table 21 are described in Table 20.

Table 20. Symbol Legend

Symbol	Meaning
OVERBAR	Signals with overbars, such as $\overline{TA}$ , are active low.
UTM	Indicates that a signal is part of the UTOPIA master interface.
UTS	Indicates that a signal is part of the UTOPIA slave interface.
UT8	Indicates that a signal is part of the 8-bit UTOPIA interface.
UT16	Indicates that a signal is part of the 16-bit UTOPIA interface.
MII	Indicates that a signal is part of the media independent interface.

Table 21. Pinout List

Pin Name	Ball
BR	W5
BG	F4
ABB/IRQ2	E2
TS	E3
A0	G1
A1	H5
A2	H2
A3	H1
A4	J5
A5	J4
A6	J3
A7	J2

Table 21. Pinout List (continued)

Pin Name	Ball
D32	E18
D33	B17
D34	A15
D35	A12
D36	D11
D37	C8
D38	E7
D39	A3
D40	D18
D41	A17
D42	A14
D43	B12
D44	A10
D45	D8
D46	B6
D47	C4
D48	C18
D49	E16
D50	B14
D51	C12
D52	B10
D53	A7
D54	C6
D55	D5
D56	B18
D57	B16
D58	E14
D59	D12
D60	C10
D61	E8
D62	D6
D63	C2
DP0/ $\overline{\text{RSRV}}/\text{EXT\_BR2}$	B22
$\overline{\text{IRQ1}}/\text{DP1}/\text{EXT\_BG2}$	A22
$\overline{\text{IRQ2}}/\text{DP2}/\text{TLBISYNC}/\text{EXT\_DBG2}$	E21

Table 21. Pinout List (continued)

Pin Name	Ball
IRQ3/DP3/CKSTP_OUT/EXT_BR3	D21
IRQ4/DP4/CORE_SRESET/EXT_BG3	C21
IRQ5/DP5/TBEN/EXT_DBG3	B21
IRQ6/DP6/CSE0	A21
IRQ7/DP7/CSE1	E20
PSDVAL	V3
TA	C22
TEA	V5
GBL/IRQ1	W1
C1/BADDR29/IRQ2	U2
WT/BADDR30/IRQ3	U3
L2_HIT/IRQ4	Y4
CPU_BG/BADDR31/IRQ5	U4
CPU_DBG	R2
CPU_BR	Y3
CS0	F25
CS1	C29
CS2	E27
CS3	E28
CS4	F26
CS5	F27
CS6	F28
CS7	G25
CS8	D29
CS9	E29
CS10/BCTL1	F29
CS11/AP0	G28
BADDR27	T5
BADDR28	U1
ALE	T2
BCTL0	A27
PWE0/PSDDQM0/PBS0	C25
PWE1/PSDDQM1/PBS1	E24
PWE2/PSDDQM2/PBS2	D24
PWE3/PSDDQM3/PBS3	C24



Table 21. Pinout List (continued)

Pin Name	Ball
PWE4/PSDDQM4/PBS4	B26
PWE5/PSDDQM5/PBS5	A26
PWE6/PSDDQM6/PBS6	B25
PWE7/PSDDQM7/PBS7	A25
PSDA10/PGPL0	E23
PSDWE/PGPL1	B24
POE/PSDRAS/PGPL2	A24
PSDCAS/PGPL3	B23
PGTA/PUPMWAIT/PGPL4/PPBS	A23
PSDAMUX/PGPL5	D22
LWE0/LSDDQM0/LBS0/PCI_CFG0 <sup>1</sup>	H28
LWE1/LSDDQM1/LBS1/PCI_CFG1 <sup>1</sup>	H27
LWE2/LSDDQM2/LBS2/PCI_CFG2 <sup>1</sup>	H26
LWE3/LSDDQM3/LBS3/PCI_CFG3 <sup>1</sup>	G29
LSDA10/LGPL0/PCI_MODCKH0 <sup>1</sup>	D27
LSDWE/LGPL1/PCI_MODCKH1 <sup>1</sup>	C28
LOE/LSDRAS/LGPL2/PCI_MODCKH2 <sup>1</sup>	E26
LSDCAS/LGPL3/PCI_MODCKH3 <sup>1</sup>	D25
LGTA/LUPMWAIT/LGPL4/LPBS	C26
LGPL5/LSDAMUX/PCI_MODCK <sup>1</sup>	B27
LWR	D28
L_A14/PAR <sup>1</sup>	N27
L_A15/FRAME <sup>1</sup> /SMI	T29
L_A16/TRDY <sup>1</sup>	R27
L_A17/IRDY <sup>1</sup> /CKSTP_OUT	R26
L_A18/STOP <sup>1</sup>	R29
L_A19/DEVSEL <sup>1</sup>	R28
L_A20/IDSEL <sup>1</sup>	W29
L_A21/PERR <sup>1</sup>	P28
L_A22/SERR <sup>1</sup>	N26
L_A23/REQ0 <sup>1</sup>	AA27
L_A24/REQ1 <sup>1</sup> /HSEJSW <sup>1</sup>	P29
L_A25/GNT0 <sup>1</sup>	AA26
L_A26/GNT1 <sup>1</sup> /HSLED <sup>1</sup>	N25
L_A27/GNT2 <sup>1</sup> /HSENUM <sup>1</sup>	AA25

Table 21. Pinout List (continued)

Pin Name	Ball
LCL_D31/AD31 <sup>1</sup>	AA28
LCL_DP0/C0 <sup>1</sup> /BE0 <sup>1</sup>	L28
LCL_DP1/C1 <sup>1</sup> /BE1 <sup>1</sup>	N28
LCL_DP2/C2 <sup>1</sup> /BE2 <sup>1</sup>	T28
LCL_DP3/C3 <sup>1</sup> /BE3 <sup>1</sup>	W28
IRQ0/NMI_OUT	T1
IRQ7/INT_OUT/APE	D1
TRST	AH3
TCK	AG5
TMS	AJ3
TDI	AE6
TDO	AF5
TRIS	AB4
PORESET	AG6
HRESET	AH5
SRESET	AF6
QREQ	AA3
RSTCONF	AJ4
MODCK1/AP1/TC0/BNKSEL0	W2
MODCK2/AP2/TC1/BNKSEL1	W3
MODCK3/AP3/TC2/BNKSEL2	W4
XFC	AB2
CLKIN1	AH4
PA0/RESTART1/DREQ3/FCC2_UTM_TXADDR2	AC29 <sup>2</sup>
PA1/REJECT1/FCC2_UTM_TXADDR1/DONE3	AC25 <sup>2</sup>
PA2/CLK20/FCC2_UTM_TXADDR0/DACK3	AE28 <sup>2</sup>
PA3/CLK19/FCC2_UTM_RXADDR0/DACK4/L1RXD1A2	AG29 <sup>2</sup>
PA4/REJECT2/FCC2_UTM_RXADDR1/DONE4	AG28 <sup>2</sup>
PA5/RESTART2/DREQ4/FCC2_UTM_RXADDR2	AG26 <sup>2</sup>
PA6/L1RSYNCA1	AE24 <sup>2</sup>
PA7/SMSYN2/L1TSYNCA1/L1GNTA1	AH25 <sup>2</sup>
PA8/SMRXD2/L1RXD0A1/L1RXDA1	AF23 <sup>2</sup>
PA9/SMTXD2/L1TXD0A1	AH23 <sup>2</sup>
PA10/FCC1_UT8_RXD0/FCC1_UT16_RXD8/MSNUM5	AE22 <sup>2</sup>
PA11/FCC1_UT8_RXD1/FCC1_UT16_RXD9/MSNUM4	AH22 <sup>2</sup>

Table 21. Pinout List (continued)

Pin Name	Ball
PA12/FCC1_UT8_RXD2/FCC1_UT16_RXD10/MSNUM3	AJ21 <sup>2</sup>
PA13/FCC1_UT8_RXD3/FCC1_UT16_RXD11/MSNUM2	AH20 <sup>2</sup>
PA14/FCC1_UT8_RXD4/FCC1_UT16_RXD12/FCC1_RXD3	AG19 <sup>2</sup>
PA15/FCC1_UT8_RXD5/FCC1_UT16_RXD13/FCC1_RXD2	AF18 <sup>2</sup>
PA16/FCC1_UT8_RXD6/FCC1_UT16_RXD14/FCC1_RXD1	AF17 <sup>2</sup>
PA17/FCC1_UT8_RXD7/FCC1_UT16_RXD15/FCC1_RXD0/FCC1_RXD	AE16 <sup>2</sup>
PA18/FCC1_UT8_TXD7/FCC1_UT16_TXD15/FCC1_TXD0/FCC1_TXD	AJ16 <sup>2</sup>
PA19/FCC1_UT8_TXD6/FCC1_UT16_TXD14/FCC1_TXD1	AG15 <sup>2</sup>
PA20/FCC1_UT8_TXD5/FCC1_UT16_TXD13/FCC1_TXD2	AJ13 <sup>2</sup>
PA21/FCC1_UT8_TXD4/FCC1_UT16_TXD12/FCC1_TXD3	AE13 <sup>2</sup>
PA22/FCC1_UT8_TXD3/FCC1_UT16_TXD11	AF12 <sup>2</sup>
PA23/FCC1_UT8_TXD2/FCC1_UT16_TXD10	AG11 <sup>2</sup>
PA24/FCC1_UT8_TXD1/FCC1_UT16_TXD9/MSNUM1	AH9 <sup>2</sup>
PA25/FCC1_UT8_TXD0/FCC1_UT16_TXD8/MSNUM0	AJ8 <sup>2</sup>
PA26/FCC1_UTM_RXCLAV/FCC1_UTS_RXCLAV/FCC1_MII_RX_ER	AH7 <sup>2</sup>
PA27/FCC1_UT_RXSOC/FCC1_MII_RX_DV	AF7 <sup>2</sup>
PA28/FCC1_UTM_RXENB/FCC1_UTS_RXENB/FCC1_MII_TX_EN	AD5 <sup>2</sup>
PA29/FCC1_UT_TXSOC/FCC1_MII_TX_ER	AF1 <sup>2</sup>
PA30/FCC1_UTM_TXCLAV/FCC1_UTS_TXCLAV/FCC1_MII_CRS/ FCC1_RTS	AD3 <sup>2</sup>
PA31/FCC1_UTM_TXENB/FCC1_UTS_TXENB/FCC1_MII_COL	AB5 <sup>2</sup>
PB4/FCC3_TXD3/FCC2_UT8_RXD0/L1RSYNCA2/FCC3_RTS	AD28 <sup>2</sup>
PB5/FCC3_TXD2/FCC2_UT8_RXD1/L1TSYNCA2/L1GNTA2	AD26 <sup>2</sup>
PB6/FCC3_TXD1/FCC2_UT8_RXD2/L1RXDA2/L1RXD0A2	AD25 <sup>2</sup>
PB7/FCC3_TXD0/FCC3_TXD/FCC2_UT8_RXD3/L1TXDA2/L1TXD0A2	AE26 <sup>2</sup>
PB8/FCC2_UT8_TXD3/FCC3_RXD0/FCC3_RXD/TXD3/L1RSYNCD1	AH27 <sup>2</sup>
PB9/FCC2_UT8_TXD2/FCC3_RXD1/L1TXD2A2/L1TSYNCD1/L1GNTD1	AG24 <sup>2</sup>
PB10/FCC2_UT8_TXD1/FCC3_RXD2/L1RXDD1	AH24 <sup>2</sup>
PB11/FCC3_RXD3/FCC2_UT8_TXD0/L1TXDD1	AJ24 <sup>2</sup>
PB12/FCC3_MII_CRS/L1CLKOB1/L1RSYNCC1/TXD2	AG22 <sup>2</sup>
PB13/FCC3_MII_COL/L1RQB1/L1TSYNCC1/L1GNTC1/L1TXD1A2	AH21 <sup>2</sup>
PB14/FCC3_MII_TX_EN/RXD3/L1RXDC1	AG20 <sup>2</sup>
PB15/FCC3_MII_TX_ER/RXD2/L1TXDC1	AF19 <sup>2</sup>
PB16/FCC3_MII_RX_ER/L1CLKOA1/CLK18	AJ18 <sup>2</sup>
PB17/FCC3_MII_RX_DV/L1RQA1/CLK17	AJ17 <sup>2</sup>

Table 21. Pinout List (continued)

Pin Name	Ball
PB18/FCC2_UT8_RXD4/FCC2_RXD3/L1CLKOD2/L1RXD2A2	AE14 <sup>2</sup>
PB19/FCC2_UT8_RXD5/FCC2_RXD2/L1RQD2/L1RXD3A2	AF13 <sup>2</sup>
PB20/FCC2_UT8_RXD6/FCC2_RXD1/L1RSYNCD2/L1TXD1A1	AG12 <sup>2</sup>
PB21/FCC2_UT8_RXD7/FCC2_RXD0/FCC2_RXD/L1TSYNCD2/L1GNTD2/L1TXD2A1	AH11 <sup>2</sup>
PB22/FCC2_UT8_TXD7/FCC2_TXD0/FCC2_TXD/L1RXD1A1/L1RXDD2	AH16 <sup>2</sup>
PB23/FCC2_UT8_TXD6/FCC2_TXD1/L1RXD2A1/L1TXDD2	AE15 <sup>2</sup>
PB24/FCC2_UT8_TXD5/FCC2_TXD2/L1RXD3A1/L1RSYNCC2	AJ9 <sup>2</sup>
PB25/FCC2_UT8_TXD4/FCC2_TXD3/L1TSYNCC2/L1GNTC2/L1TXD3A1	AE9 <sup>2</sup>
PB26/FCC2_MII_CRS/FCC2_UT8_TXD1/L1RXDC2	AJ7 <sup>2</sup>
PB27/FCC2_MII_COL/FCC2_UT8_TXD0/L1TXDC2	AH6 <sup>2</sup>
PB28/FCC2_MII_RX_ER/FCC2_RTS/L1TSYNCB2/L1GNTB2/TXD1	AE3 <sup>2</sup>
PB29/FCC2_UTM_RXCLAV/FCC2_UTS_RXCLAV/L1RSYNCB2/FCC2_MII_TX_EN	AE2 <sup>2</sup>
PB30/FCC2_MII_RX_DV/FCC2_UT_TXSOC/L1RXDB2	AC5 <sup>2</sup>
PB31/FCC2_MII_TX_ER/FCC2_UT_RXSOC/L1TXDB2	AC4 <sup>2</sup>
PC0/DREQ1/BRGO7/SMSYN2/L1CLKOA2	AB26 <sup>2</sup>
PC1/DREQ2/BRGO6/L1RQA2	AD29 <sup>2</sup>
PC2/FCC3_CD/FCC2_UT8_TXD3/DONE2	AE29 <sup>2</sup>
PC3/FCC3_CTS/FCC2_UT8_TXD2/DACK2/CTS4	AE27 <sup>2</sup>
PC4/FCC2_UTM_RXENB/FCC2_UTS_RXENB/SI2_L1ST4/FCC2_CD	AF27 <sup>2</sup>
PC5/FCC2_UTM_TXCLAV/FCC2_UTS_TXCLAV/SI2_L1ST3/FCC2_CTS	AF24 <sup>2</sup>
PC6/FCC1_CD/L1CLKOC1/FCC1_UTM_RXADDR2/FCC1_UTS_RXADDR/FCC1_UTM_RXCLAV1	AJ26 <sup>2</sup>
PC7/FCC1_CTS/L1RQC1/FCC1_UTM_TXADDR2/FCC1_UTS_TXADDR2/FCC1_UTM_TXCLAV1	AJ25 <sup>2</sup>
PC8/CD4/RENA4/FCC1_UT16_TXD0/SI2_L1ST2/CTS3	AF22 <sup>2</sup>
PC9/CTS4/CLSN4/FCC1_UT16_TXD1/SI2_L1ST1/L1TSYNCA2/L1GNTA2	AE21 <sup>2</sup>
PC10/CD3/RENA3/FCC1_UT16_TXD2/SI1_L1ST4/FCC2_UT8_RXD3	AF20 <sup>2</sup>
PC11/CTS3/CLSN3/L1CLKOD1/L1TXD3A2/FCC2_UT8_RXD2	AE19 <sup>2</sup>
PC12/CD2/RENA2/SI1_L1ST3/FCC1_UTM_RXADDR1/FCC1_UTS_RXADDR1	AE18 <sup>2</sup>
PC13/CTS2/CLSN2/L1RQD1/FCC1_UTM_TXADDR1/FCC1_UTS_TXADDR1	AH18 <sup>2</sup>
PC14/CD1/RENA1/FCC1_UTM_RXADDR0/FCC1_UTS_RXADDR0	AH17 <sup>2</sup>
PC15/CTS1/CLSN1/SMTXD2/FCC1_UTM_TXADDR0/FCC1_UTS_TXADDR0	AG16 <sup>2</sup>

**Table 23. Document Revision History (continued)**

Revision	Date	Substantive Changes
0.9	8/2003	<ul style="list-style-type: none"> <li>Note: In revision 0.3, sp30 (<a href="#">Table 10</a>) was changed. This change was not previously recorded in this “Document Revision History” Table.</li> <li>Removal of “HiP4 PowerQUICC II Documentation” table. These supplemental specifications have been replaced by revision 1 of the <i>MPC8260 PowerQUICC II™ Family Reference Manual</i>.</li> <li><a href="#">Figure 1</a> and <a href="#">Section 1, “Features”</a>: Addition of MPC8255 notes</li> <li>Addition of <a href="#">Figure 2</a></li> <li>Addition of VCCSYN to “Note: Core, PLL, and I/O Supply Voltages” following <a href="#">Table 2</a></li> <li>Addition of note 1 to <a href="#">Table 3</a></li> <li><a href="#">Table 4</a>: Changes to <math>\theta_{JA}</math> and <math>\theta_{JB}</math> and <math>\theta_{JC}</math>.</li> <li>Addition of notes or modifications to <a href="#">Figure 6</a>, <a href="#">Figure 7</a>, and <a href="#">Figure 8</a></li> <li><a href="#">Table 9</a>: Change of sp10.</li> <li>Addition of <a href="#">Table 15</a>.</li> <li>Addition of note 2 to <a href="#">Table 21</a></li> <li><a href="#">Table 21</a>: Addition of FCC2 Rx and Tx [3,4] to CPM pins PD7, PD18, PD19, and PD29. Also, the addition of SPICLK to PC19. They are documented correctly in the parallel I/O ports chapter in the <i>MPC8260 PowerQUICC II™ Family Reference Manual</i> but had previously been omitted from <a href="#">Table 21</a>.</li> </ul>
0.8	1/2003	<ul style="list-style-type: none"> <li><a href="#">Table 2</a>: Modification to supply voltage ranges reflected in notes 2, 3, and 4.</li> <li><a href="#">Table 4</a>: Addition of <math>\theta_{JB}</math> and <math>\theta_{JC}</math>.</li> <li><a href="#">Table 7</a>, <a href="#">Figure 8</a>: Addition of sp42a/sp43a.</li> <li><a href="#">Figure 3</a>, <a href="#">Figure 4</a>: Addition of note for FCC output.</li> <li><a href="#">Figure 5</a>, <a href="#">Figure 6</a>, <a href="#">Figure 7</a>: Addition of notes.</li> <li><a href="#">Table 14</a>, <a href="#">Table 17</a>, and <a href="#">Table 19</a>: Removal of PLL bypass mode from clock tables.</li> </ul>
0.7	5/2002	<ul style="list-style-type: none"> <li><a href="#">Section 1, “Features”</a>: minimum supported core frequency of 150 MHz</li> <li><a href="#">Section 1, “Features”</a>: updated performance values (under “Dual-issue integer core”)</li> <li><a href="#">Table 2</a>: Note 2 (changes in italics): “...less than or equal to 233 MHz, 166 MHz CPM...”</li> <li><a href="#">Table 2</a>: Addition of note 3.</li> </ul>
0.6	3/2002	<ul style="list-style-type: none"> <li><a href="#">Table 21</a>: Modified notes to pins AE11 and AF25.</li> </ul>
0.5	3/2002	<ul style="list-style-type: none"> <li><a href="#">Table 21</a>: Modified notes to pins AE11 and AF25.</li> <li><a href="#">Table 21</a>: Addition of note to pins AA1 and AG4 (Therm0 and Therm1).</li> </ul>
0.4	2/2002	<ul style="list-style-type: none"> <li>Note 2 for <a href="#">Table 2</a> (changes in italics): “...greater than or equal to 266 MHz, 200 MHz CPM...”</li> <li><a href="#">Table 19</a>: Core and bus frequency values for the following ranges of MODCK_HMODCK: 0011_000 to 0011_100 and 1011_000 to 1011_1000</li> <li><a href="#">Table 21</a>: Notes added to pins at AE11, AF25, U5, and V4.</li> </ul>
0.3	11/2001	<ul style="list-style-type: none"> <li><a href="#">Table 1</a>: note 3</li> <li><a href="#">Section 2.1</a>: Removal of “Warning” recommending use of bootstrap diodes. They are not needed.</li> <li><a href="#">Table 9</a>: Change to sp12.</li> <li><a href="#">Table 10</a>: Change to sp32.</li> <li>Note 2 for <a href="#">Table 16</a> and <a href="#">Table 17</a></li> <li>Addition of note at beginning of <a href="#">Section 3.2</a></li> <li>Note 1 for <a href="#">Table 18</a> and <a href="#">Table 19</a></li> <li><a href="#">Table 21</a>: Additions to B27, C28, D25, D27, E26, G29, H26–28, N25, P29, AF25, AA25, AB27</li> </ul>
0.2	11/2001	<ul style="list-style-type: none"> <li>Revision of <a href="#">Table 5</a>, “Power Dissipation”</li> <li>Modifications to <a href="#">Figure 9</a>, <a href="#">Table 2</a>, <a href="#">Table 10</a>, <a href="#">Table 11</a>, and <a href="#">Table 18</a></li> <li>Modification to pinout diagram, <a href="#">Figure 13</a></li> <li>Additional revisions to text and figures throughout</li> </ul>
0.1	8/2001	<ul style="list-style-type: none"> <li><a href="#">Table 8</a>: Change to sp20/sp21.</li> </ul>
0	—	Initial version